

N-Channel MOSFET

General Description

The WSD3060DN33 is the highest performance trench N-Channel MOSFETs with extreme high cell density, which provide excellent $R_{DS(ON)}$ and gate charge for most of the synchronous buck converter applications.

The WSD3060DN33 meet the RoHS and Green Product requirement, 100% E_{AS} guaranteed with full function reliability approved.

Features

- Advanced high cell density Trench technology
- Super Low Gate Charge
- Excellent CdV/dt effect decline
- 100% E_{AS} Guaranteed
- Green Device Available

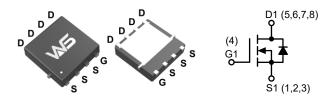
Product Summery

BV _{DSS}	R _{DS(ON)}	I _D	
30V	4.7mΩ	60A	

Applications

- High Frequency Point-of-Load Synchronous Buck Converter for MB/NB/UMPC/VGA
- Networking DC-DC Power System
- Load Switch

DFN3X3-8L Pin Configuration



Absolute Maximum Ratings

Symbol	Parameter	Rating	Units
V _{DS}	Drain-Source Voltage	30	V
V _{GS} Gate-Source Voltage		±20	V
I _D @T _C =25°C	Continuous Drain Current, V _{GS} @ 10V ¹	60	
I _D @T _C =100°C	Continuous Drain Current, V _{GS} @ 10V ¹	48	
I _D @T _A =25°C	Continuous Drain Current, V _{GS} @ 10V ¹ 13		A
I _D @T _A =70°C	Continuous Drain Current, V _{GS} @ 10V ¹	10	
I _{DM} @T _C =25°C	Pulsed Drain Current ²	140	
E _{AS} Avalanche Energy, Single Pulse (L=0.5mH) ³		100	mJ
I _{AS}	Avalanche Current, Single pulse(L=0.5mH) ³	20	А
P _D @T _C =25°C	Total Power Dissipation ⁴	50	W
P _D @T _A =25°C	Total Power Dissipation ⁴	3.6	VV
T _{STG}	Storage Temperature Range	-55 to 150	°C
T _J	Operating Junction Temperature Range	-55 to 150	C

Thermal Data

Symbol	Symbol Parameter		Max.	Units
$R_{ heta JA}$	Thermal Resistance, Junction-to-Ambient ¹		70	°C/W
$R_{ heta JC}$	Thermal Resistance, Junction-to-Case ¹		2.5	C/VV



N-Channel MOSFET

Electrical Characteristics (T_J=25°C, Unless Otherwise Noted)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Units
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V , I _D =250μA	30			V
$\Delta BV_{DSS}/\Delta T_{J}$	BV _{DSS} Temperature Coefficient	Reference to 25°C, I _D =1mA		0.028		V/°C
В	Static Ducin Service On Begintaine 2	V _{GS} =10V , I _D =40A		4.7	5.7	mΩ
$R_{DS(ON)}$	Static Drain-Source On-Resistance ²	V _{GS} =4.5V , I _D =20A		5.8	7.6	11177
$V_{GS(th)}$	Gate Threshold Voltage	\/ -\/ -250\	1.2	1.8	2.5	V
$\Delta V_{GS(th)}$	V _{GS(th)} Temperature Coefficient	- V _{GS} =V _{DS} , I _D =250μA		-6.16		mV/°C
	Drain Source Leekage Current	V _{DS} =24V , V _{GS} =0V , T _J =25°C			1.0	
I _{DSS}	Drain-Source Leakage Current	V _{DS} =24V , V _{GS} =0V , T _J =55°C			5.0	· μΑ
I _{GSS}	Gate-Source Leakage Current	V _{GS} =±20V , V _{DS} =0V			±100	nA
9 _{fs}	Forward Transconductance	V _{DS} =5V , I _D =40A		95		S
R_g	Gate Resistance	V_{DS} =0V , V_{GS} =0V , f = 1.0MHz		2.0	2.9	Ω
Q_g	Total Gate Charge (4.5V)			20	28	
Q_{gs}	Gate-Source Charge	V_{DS} =15V , V_{GS} =4.5V , I_{D} =40A		7.6	10.6	nC
Q_{gd}	Gate-Drain Charge			7.2	10.1	
$T_{d(on)}$	Turn-On Delay Time			15	28	
T _r	Rise Time	V _{DD} =15V , V _{GEN} =10V ,		13	24	
$T_{d(off)}$	Turn-Off Delay Time	$R_G=3.3\Omega$, $I_D=1A$, $R_L=10\Omega$		32	57	ns
T _f	Fall Time			9	17	
C _{iss}	Input Capacitance			1500	1820	
C _{oss}	Output Capacitance	t Capacitance V _{DS} =15V , V _{GS} =0V , f = 1.0MHz		260	310	pF
C _{rss}	Reverse Transfer Capacitance			130	190	

Guaranteed Avalanche Characteristics

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Units
E _{AS}	Single Pulse Avalanche Energy ⁵	V _{DD} =25V , L=0.5mH , I _{AS} =20A	63			mJ

Diode Characteristics

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Units
I _S	Continuous Source Current 1,6	V =V =OV Force Current			10	_
I _{SM}	Pulsed Source Curren ^{2,6}	V _G =V _D =0V , Force Current			140	A
V _{SD}	Diode Forward Voltage ²	V _{GS} =0V , I _S =1A , T _J =25°C			1.0	V
t _{rr}	Reverse Recovery Time	L =40.4 dl/dt=100.4/us T =25°C		21		ns
Q_{rr}	Reverse Recovery Charge	I _F =40A, dI/dt=100A/μs,Τ _J =25°C		7		nC

Note:

- 1. The data tested by surface mounted on a 1 inch² FR-4 board with 2OZ copper, t<10sec.
- 2. The data tested by pulsed , pulse width $\leq 300 \mu s$, duty cycle $\leq 2\%$
- 3. The E $_{\rm AS}$ data shows Max. rating . The test condition is $\rm\,V_{DD}$ =25V, $\rm\,V_{GS}$ =10V, L=0.5mH, I $_{\rm AS}$ =20A
- 4. The power dissipation is limited by 150°C junction temperature.
- 5. The Min. value is 100% $\,{\rm E}_{\rm AS}\,$ tested guarantee.
- 6. The data is theoretically the same as I_D and I_{DM} , in real applications, should be limited by total power dissipation.





Typical Characteristics

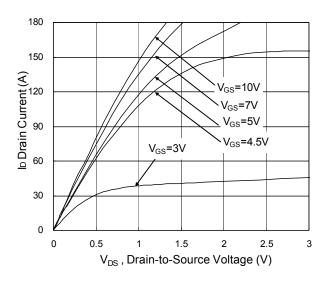


Fig.1 Typical Output Characteristics

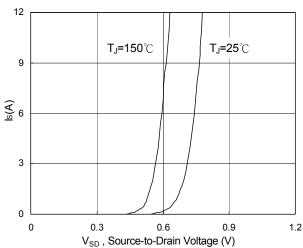


Fig.3 Forward Characteristics of Reverse

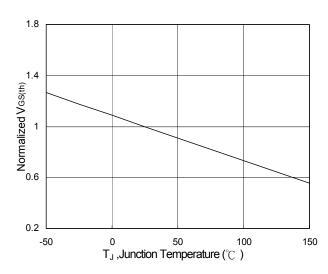


Fig.5 Normalized $V_{GS(th)}$ vs. T_J

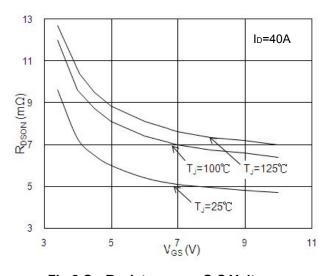


Fig.2 On-Resistance vs. G-S Voltage

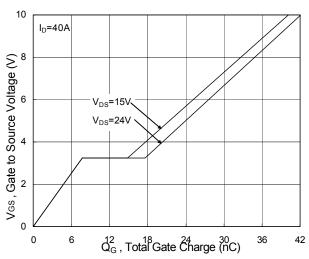


Fig.4 Gate-Charge Characteristics

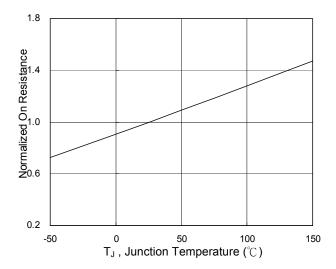


Fig.6 Normalized R_{DSON} vs. T_J



Typical Characteristics (Cont.)

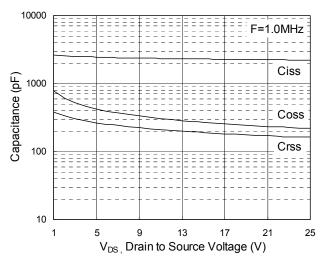


Fig.7 Capacitance

Fig.8 Safe Operating Area

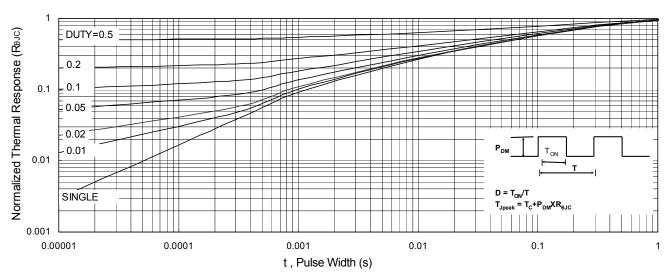


Fig.9 Normalized Maximum Transient Thermal Impedance

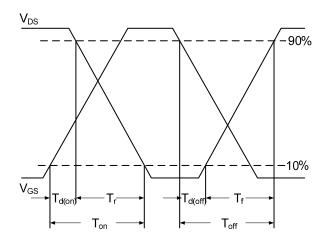


Fig.10 Switching Time Waveform

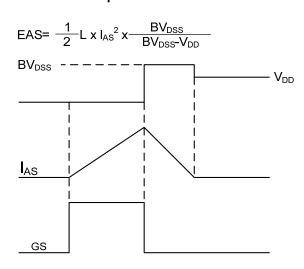
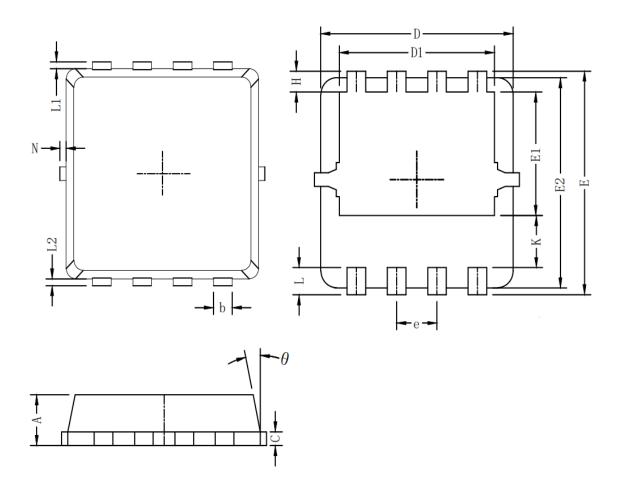


Fig.11 Unclamped Inductive Switching Waveform



Packaging information



Symbol	Dim in mm				
Syllibol	min	typ	max		
А	0.6	0.75	0.9		
b	0.2	0.3	0.4		
С	0.15	0.2	0.25		
D	3	3.1	3.2		
D1	2.3	2.45	2.6		
E	3.15	3.3	3.45		
E1	1.43	1.73	1.93		
E2	2.9	3.05	3.2		
е	0.65BSC				
Н	0.2	0.35	0.5		
K	0.57	0.77	0.87		
L	0.3	0.4	0.5		
L1/L2	0.1REF				
θ	8°	10°	13°		
N	0		0.15		



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